Product Information

DE-F573

Material description:	low-charging polyimide, amber-coloured, removable adhesive, electrical insulation according to NEMA class H requirements
Application:	labels for the electrical, electronics, automotive, aviation, and medical industries, thermal insulation for electrical installations, electrical insulation for electronic components, removable low-charging thermal masks for the protection of goldfingers of PCBs during wave soldering, solder dip, or hot air leveling (HAL)
Material thickness:	50 µm
Adhesive:	AS1, acrylic adhesive
Adhesive thickness:	25 µm
Adhesion:	light adhesion stainless steel/aluminium 20 min. 7.5 N/25 mm FTM 1 24 h 8.25 N/25 mm FTM 1
Web material:	synthetic liner
Web material thickness:	25 µm
Temperature range:	- 40 ° C to + 300 ° C
Adhesion temperature:	> + 5 °C
Print methods:	material not designed to be printed
Storage:	1 year at max. + 25 ° C and 50 % r. h., no direct sunlight

Warranty:
Our recommendations are based on our most up-to-date knowledge and experience. As the products are used outside of our control we cannot take responsibility for any damage which may be caused when using the products. This product information sheet replaces all earlier ones. All information subject to change without notice.

Dynamic Systems GmbH • Inninger Straße 11 • 82237 Wörthsee • Telefon: 08153/9096-0 • Telefax: 08153/9096-96
e-Mail: info@dynamic-systems.de • Internet: www.dynamic-systems.de • HRB Nr. 116251 Reg. Gericht München • V1.0

creation date: 2017-04-12